

FP-BGA
Commercial Temp
Industrial Temp

256K x 16

4Mb Asynchronous SRAM

6, 7, 8, 10, 12 ns
3.3 V V_{DD}
Center V_{DD} and V_{SS}
Features

- Fast access time: 6, 7, 8, 10, 12 ns
- CMOS low power operation: 170/150/130/105/95 mA at minimum cycle time
- Single 3.3 V power supply
- All inputs and outputs are TTL-compatible
- Byte control
- Fully static operation
- Industrial Temperature Option: -40° to 85°C
- Package:
 - X: 6 mm x 10 mm Fine Pitch Ball Grid Array package

Fine Pitch BGA 256K x 16 Bump Configuration

	1	2	3	4	5	6
A	$\overline{\text{LB}}$	$\overline{\text{OE}}$	A0	A1	A2	NC
B	DQ1	$\overline{\text{UB}}$	A3	A4	$\overline{\text{CE}}$	DQ16
C	DQ3	DQ2	A5	A6	DQ15	DQ14
D	VSS	DQ4	A17	A7	DQ13	VDD
E	VDD	DQ5	NC	A16	DQ12	VSS
F	DQ6	DQ7	A8	A9	DQ10	DQ11
G	DQ8	NC	A10	A11	$\overline{\text{WE}}$	DQ9
H	NC	A12	A13	A14	A15	NC

Package X
6 x 10 mm Bump Pitch
Top View

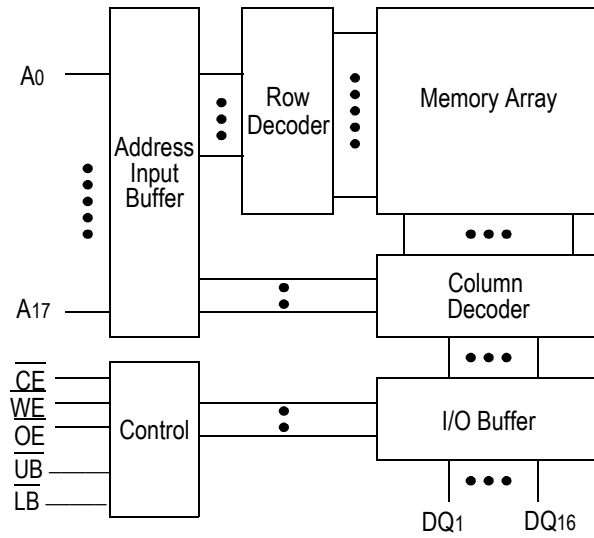
Description

The GS74117A is a high speed CMOS Static RAM organized as 262,144 words by 16 bits. Static design eliminates the need for external clocks or timing strobes. The GS operates on a single 3.3 V power supply and all inputs and outputs are TTL-compatible. The GS74117A is available in a 6 x 10 mm Fine Pitch BGA package.

Pin Descriptions

Symbol	Description
A ₀ -A ₁₇	Address input
DQ ₁ -DQ ₁₆	Data input/output
$\overline{\text{CE}}$	Chip enable input
$\overline{\text{LB}}$	Lower byte enable input (DQ ₁ to DQ ₈)
$\overline{\text{UB}}$	Upper byte enable input (DQ ₉ to DQ ₁₆)
$\overline{\text{WE}}$	Write enable input
$\overline{\text{OE}}$	Output enable input
V _{DD}	+3.3 V power supply
V _{SS}	Ground
NC	No connect

Block Diagram



Truth Table

$\overline{\text{CE}}$	$\overline{\text{OE}}$	$\overline{\text{WE}}$	$\overline{\text{LB}}$	$\overline{\text{UB}}$	DQ1 to DQ8	DQ9 to DQ16	VDD Current
H	X	X	X	X	Not Selected	Not Selected	ISB1, ISB2
L	L	H	L	L	Read	Read	I _{DD}
			L	H	Read	High Z	
			H	L	High Z	Read	
L	X	L	L	L	Write	Write	
			L	H	Write	Not Write, High Z	
			H	L	Not Write, High Z	Write	
L	H	H	X	X	High Z	High Z	
L	X	X	H	H	High Z	High Z	

Note: X: "H" or "L"

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply Voltage	V _{DD}	-0.5 to +4.6	V
Input Voltage	V _{IN}	-0.5 to V _{DD} +0.5 (≠ 4.6 V max.)	V
Output Voltage	V _{OUT}	-0.5 to V _{DD} +0.5 (≠ 4.6 V max.)	V
Allowable power dissipation	PD	0.7	W
Storage temperature	T _{STG}	-55 to 150	°C

Note:

Permanent device damage may occur if Absolute Maximum Ratings are exceeded. Functional operation shall be restricted to Recommended Operating Conditions. Exposure to higher than recommended voltages for extended periods of time could affect device reliability.

Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage for -7/-8/-10/-12	V _{DD}	3.0	3.3	3.6	V
Supply Voltage for -6	V _{DD}	3.135	3.3	3.6	V
Input High Voltage	V _{IH}	2.0	—	V _{DD} +0.3	V
Input Low Voltage	V _{IL}	-0.3	—	0.8	V
Ambient Temperature, Commercial Range	T _{Ac}	0	—	70	°C
Ambient Temperature, Industrial Range	T _{AI}	-40	—	85	°C

Notes:

1. Input overshoot voltage should be less than V_{DD} +2 V and not exceed 20 ns.
2. Input undershoot voltage should be greater than -2 V and not exceed 20 ns.

Capacitance

Parameter	Symbol	Test Condition	Max	Unit
Input Capacitance	C _{IN}	V _{IN} = 0 V	5	pF
Output Capacitance	C _{OUT}	V _{OUT} = 0 V	7	pF

Notes:

1. Tested at T_A = 25°C, f = 1 MHz
2. These parameters are sampled and are not 100% tested.

DC I/O Pin Characteristics

Parameter	Symbol	Test Conditions	Min	Max
Input Leakage Current	I _{IL}	V _{IN} = 0 to V _{DD}	-1 µA	1 µA
Output Leakage Current	I _{LO}	Output High Z V _{OUT} = 0 to V _{DD}	-1 µA	1 µA
Output High Voltage	V _{OH}	I _{OH} = -4 mA	2.4	—
Output Low Voltage	V _{OL}	I _{LO} = +4 mA	—	0.4 V

Power Supply Currents

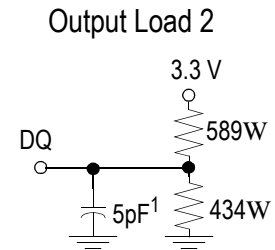
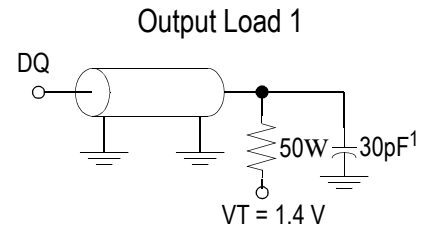
Parameter	Symbol	Test Conditions	0 to 70°C					-40 to 85°C					Unit
			6 ns	7 ns	8 ns	10 ns	12 ns	6 ns	7 ns	8 ns	10 ns	12 ns	
Operating Supply Current	I _{DD}	$\overline{CE} \text{ } \text{ } \text{ } V_{IL}$ All other inputs $\text{ } \text{ } V_{IH}$ or $\text{ } \text{ } V_{IL}$ Min. cycle time I _{OUT} = 0 mA	170	150	130	105	90	180	160	140	115	100	mA
Standby Current	I _{SB1}	$\overline{CE} \text{ } \text{ } V_{IH}$ All other inputs $\text{ } \text{ } V_{IH}$ or $\text{ } \text{ } V_{IL}$ Min. cycle time	40	28	30	25	22	50	38	40	35	32	mA
Standby Current	I _{SB2}	$\overline{CE} \text{ } \text{ } V_{DD} - 0.2V$ All other inputs $\text{ } \text{ } V_{DD} - 0.2V$ or $\text{ } \text{ } V_{IL}$	10					20					mA

AC Test Conditions

Parameter	Conditions
Input high level	$V_{IH} = 2.4\text{ V}$
Input low level	$V_{IL} = 0.4\text{ V}$
Input rise time	$t_r = 1\text{ V/ns}$
Input fall time	$t_f = 1\text{ V/ns}$
Input reference level	1.4 V
Output reference level	1.4 V
Output load	Fig. 1& 2

Note:

1. Include scope and jig capacitance.
2. Test conditions as specified with output loading as shown in **Fig. 1** unless otherwise noted.
3. Output load 2 for t_{LZ} , t_{HZ} , t_{OLZ} and t_{OHZ}

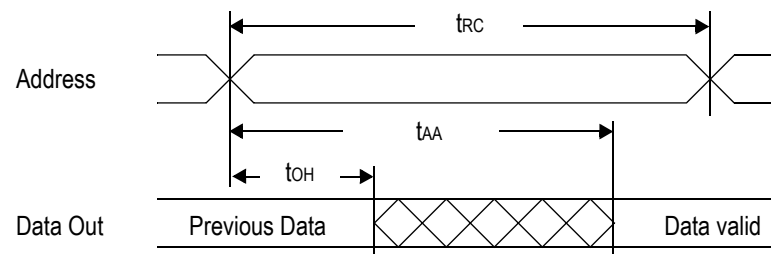


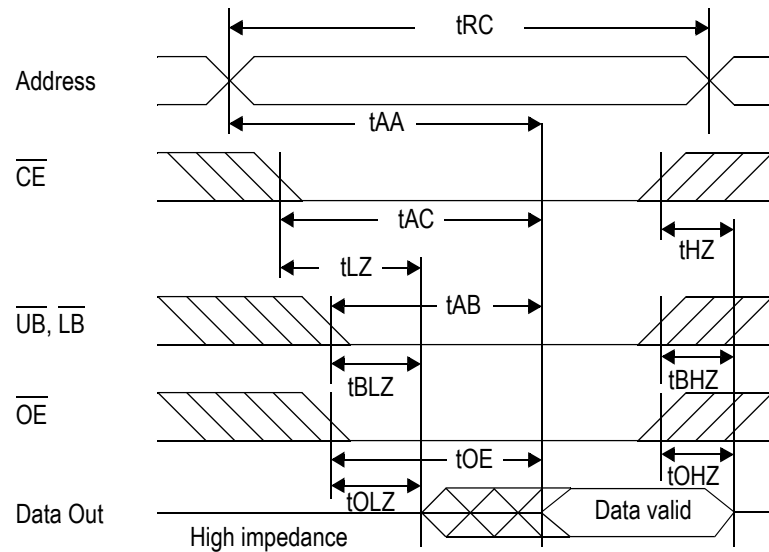
AC Characteristics
Read Cycle

Parameter	Symbol	-6		-7		-8		-10		-12		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Read cycle time	t _{RC}	6	—	7	—	8	—	10	—	12	—	ns
Address access time	t _{AA}	—	6	—	7	—	8	—	10	—	12	ns
Chip enable access time (\overline{CE})	t _{AC}	—	6	—	7	—	8	—	10	—	12	ns
Byte enable access time (\overline{UB} , \overline{LB})	t _{AB}	—	3	—	3	—	3.5	—	4	—	5	ns
Output enable to output valid (\overline{OE})	t _{OE}	—	3	—	3	—	3.5	—	4	—	5	ns
Output hold from address change	t _{OH}	3	—	3	—	3	—	3	—	3	—	ns
Chip enable to output in low Z (\overline{CE})	t _{LZ} *	3	—	3	—	3	—	3	—	3	—	ns
Output enable to output in low Z (\overline{OE})	t _{OLZ} *	0	—	0	—	0	—	0	—	0	—	ns
Byte enable to output in low Z (\overline{UB} , \overline{LB})	t _{BLZ} *	0	—	0	—	0	—	0	—	0	—	ns
Chip disable to output in High Z (\overline{CE})	t _{HZ} *	—	3	—	3.5	—	4	—	5	—	6	ns
Output disable to output in High Z (\overline{OE})	t _{OHZ} *	—	3	—	3	—	3.5	—	4	—	5	ns
Byte disable to output in High Z (\overline{UB} , \overline{LB})	t _{BHZ} *	—	3	—	3	—	3.5	—	4	—	5	ns

* These parameters are sampled and are not 100% tested.

Read Cycle 1: $\overline{CE} = \overline{OE} = V_{IL}$, $\overline{WE} = V_{IH}$, \overline{UB} and, or $\overline{LB} = V_{IL}$

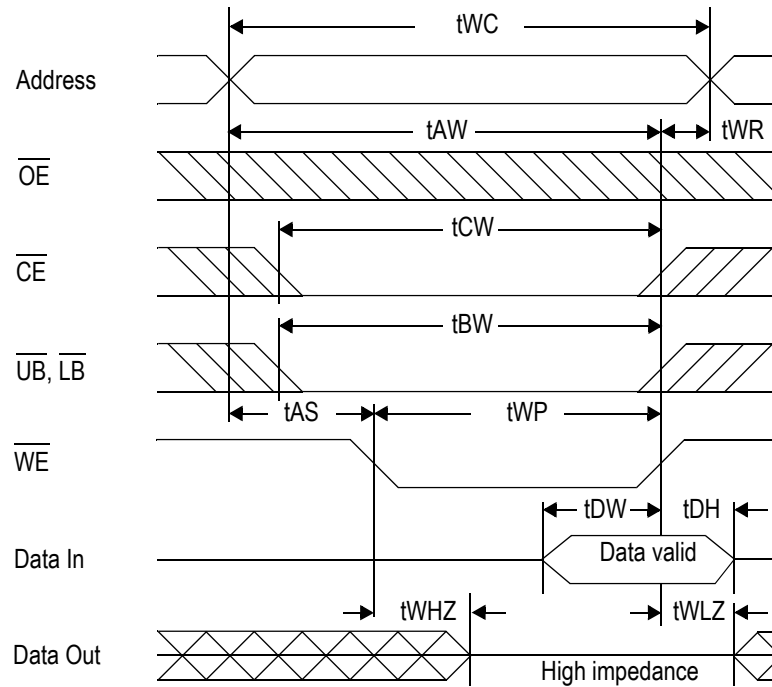


Read Cycle 2: $\overline{WE} = V_{IH}$

Write Cycle

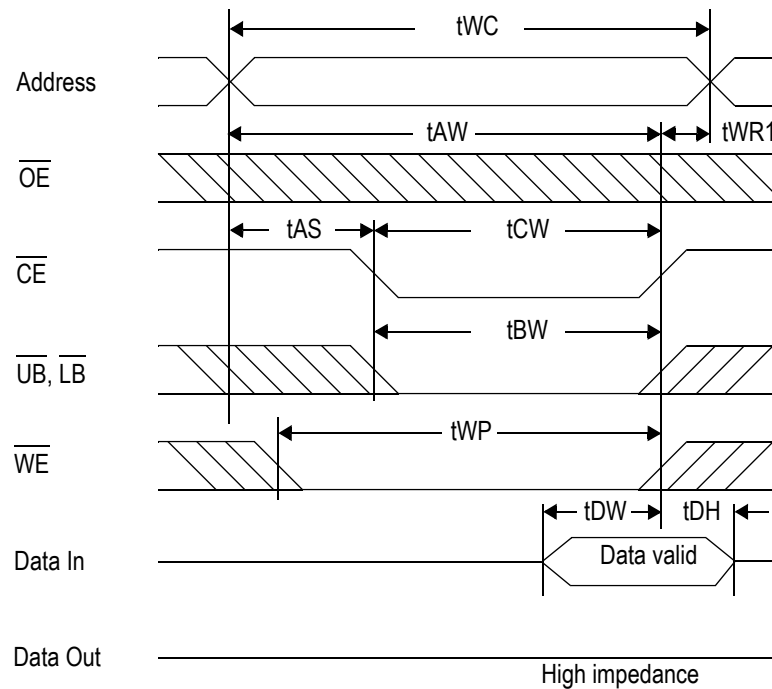
Parameter	Symbol	-6		-7		-8		-10		-12		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Write cycle time	t_{WC}	6	—	7	—	8	—	10	—	12	—	ns
Address valid to end of write	t_{AW}	5	—	5	—	5.5	—	7	—	8	—	ns
Chip enable to end of write	t_{CW}	5	—	5	—	5.5	—	7	—	8	—	ns
Byte enable to end of write	t_{BW}	5	—	5	—	5.5	—	7	—	8	—	ns
Data set up time	t_{DW}	3	—	3.5	—	4	—	4.5	—	6	—	ns
Data hold time	t_{DH}	0	—	0	—	0	—	0	—	0	—	ns
Write pulse width	t_{WP}	5	—	5	—	5.5	—	7	—	8	—	ns
Address set up time	t_{AS}	0	—	0	—	0	—	0	—	0	—	ns
Write recovery time (\overline{WE})	t_{WR}	0	—	0	—	0	—	0	—	0	—	ns
Write recovery time (\overline{CE})	t_{WR1}	0	—	0	—	0	—	0	—	0	—	ns
Output Low Z from end of write	t_{WLZ}^*	3	—	3	—	3	—	3	—	3	—	ns
Write to output in High Z	t_{WHZ}^*	—	3	—	3	—	3.5	—	4	—	5	ns

* These parameters are sampled and are not 100% tested.

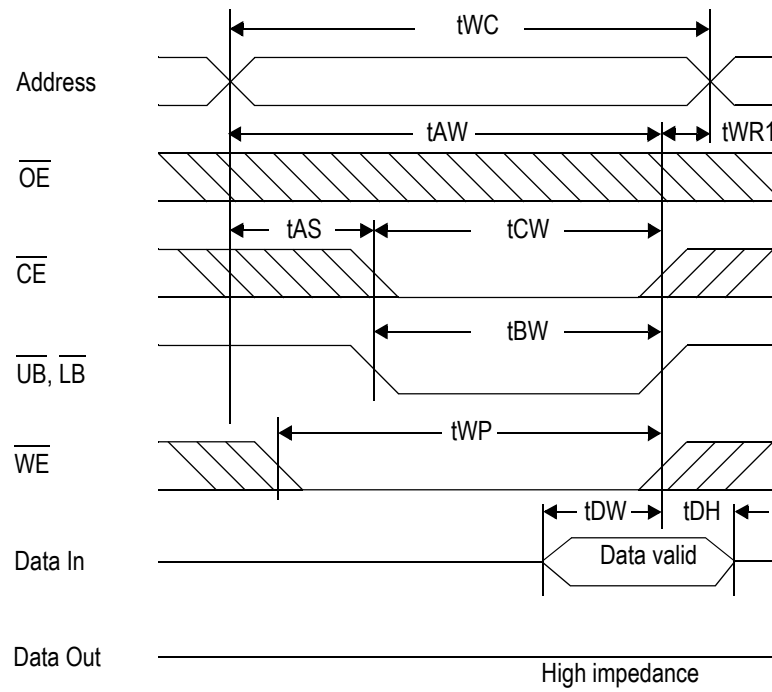
Write Cycle 1: \overline{WE} control



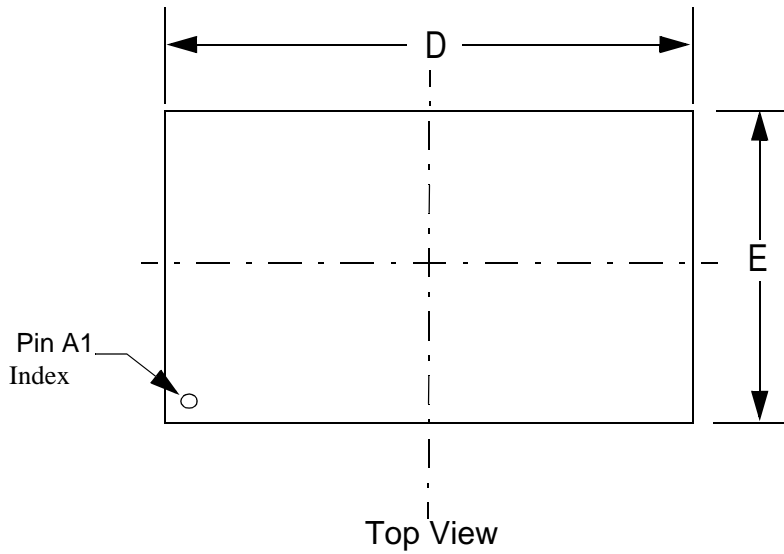
Write Cycle 2: \overline{CE} control



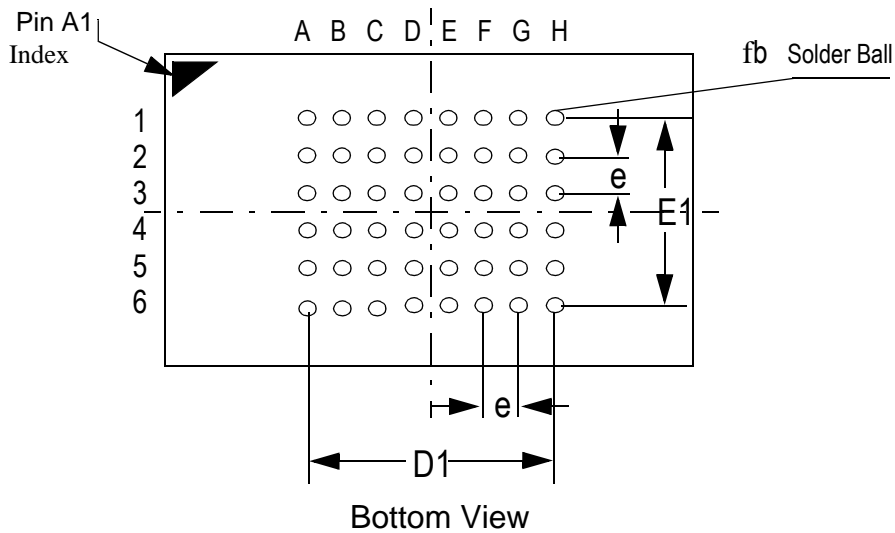
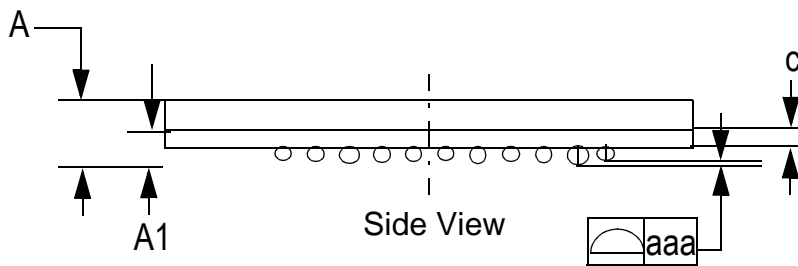
Write Cycle 3: \overline{UB} , \overline{LB} control



Package X—6 mm x 10 mm FP-BGA



Symbol	Unit: mm
A	1.10±0.10
A1	0.20~0.30
fb	f0.30~0.40
c	0.36(TYP)
D	10.0±0.05
D1	5.25
E	6.0±0.05
E1	3.75
e	0.75(TYP)
aaa	0.10



Ordering Information

Part Number *	Package	Access Time	Temp. Range	Status
GS74117AX-6	6 mm x 10 mm BGA	6 ns	Commercial	
GS74117AX-7	6 mm x 10 mm BGA	7 ns	Commercial	
GS74117AX-8	6 mm x 10 mm BGA	8 ns	Commercial	
GS74117AX-10	6 mm x 10 mm BGA	10 ns	Commercial	
GS74117AX-12	6 mm x 10 mm BGA	12 ns	Commercial	
GS74117AX-6I	6 mm x 10 mm BGA	6 ns	Industrial	
GS74117AX-7I	6 mm x 10 mm BGA	7 ns	Industrial	
GS74117AX-8I	6 mm x 10 mm BGA	8 ns	Industrial	
GS74117AX-10I	6 mm x 10 mm BGA	10 ns	Industrial	
GS74117AX-12I	6 mm x 10 mm BGA	12 ns	Industrial	

* Customers requiring delivery in Tape and Reel should add the character "T" to the end of the part number. For example:
GS74117AX-8T

4Mb Asynchronous Datasheet Revision History

Rev. Code: Old; New	Types of Changes Format or Content	Page #/Revisions/Reason
74117A_r1	Format/Content	• Creation of new datasheet
74117A_r1; 74117A_r1_01	Content	• Updated Recommended Operating Conditions table on page 3 • Updated Read Cycle and Write Cycle AC Characteristics tables